

N-Channel 40-V (D-S) MOSFET

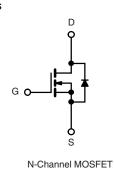
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)		
40	0.0088 at V _{GS} = 10 V	50	16 nC		
40	0.0105 at V _{GS} = 4.5 V	50	10110		

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested
- 100 % Rg Tested
- PWM Optimized
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- LCD Display Backlight Inverters
- DC/DC Converters



TO-252 G D S Top View

Ordering Information: SUD50N04-8m8P-4GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	± 20	
	T _C = 25 °C		50 ^a	
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C	1-	44	
Continuous Drain Current (1j = 150°C)	T _A = 25 °C	I _D	14 ^b	
	T _A = 70 °C		11.2 ^b	A
Pulsed Drain Current		I _{DM}	100	
Continuous Source-Drain Diode Current	T _C = 25 °C	I	40	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.6 ^b	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	30	
Avalanche Energy	L = 0.1 mm	E _{AS}	45	mJ
	T _C = 25 °C		48.1	
Maximum Power Dissipation	T _C = 70 °C	PD	30.8	w
Maximum Fower Dissipation	T _A = 25 °C	F D	3.1 ^b	VV
	T _A = 70 °C		2.0 ^b	
Operating Junction and Storage Temperature Ra	T _J , T _{stq}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	32	40	°C/W	
Maximum Junction-to-Case	Steady State	R _{thJC}	2.1	2.6	0/11	

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.



SUD50N04-8m8P

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	40			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			44		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 1.0 mA		- 5.9		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	1.5		3.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
	_	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 70 \text{ °C}$			20	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 10 V$	50			Α
Ducin Courses On Otata Desistanced		V _{GS} = 10 V, I _D = 20 A		0.0069	0.0088	- Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 15 \text{ A}$		0.0084	0.0105	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		75		S
Dynamic ^b		·		·		
Input Capacitance	C _{iss}			2400		pF
Output Capacitance	C _{oss}	V _{DS} = 20 V, V _{GS} = 0 V, f = 1 MHz		260		
Reverse Transfer Capacitance	C _{rss}			100		
Tatal Oata Obarra		$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		37	56	nC
Total Gate Charge	Qg			16	24	
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		6.5		
Gate-Drain Charge	Q _{gd}			4.5		
Gate Resistance	R _g	f = 1 MHz	2.5	5.5	8.5	Ω
Turn-On Delay Time	t _{d(on)}			30	45	-
Rise Time	t _r	V_{DD} = 20 V, R_L = 1 Ω		15	25	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 20 A, V_GEN = 4.5 V, R_g = 1 Ω		45	70	
Fall Time	t _f			15	25	no
Turn-On Delay Time	t _{d(on)}			9	15	ns
Rise Time	t _r	V_{DD} = 20 V, R_L = 1 Ω		5	10	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 20 A, V_GEN = 10 V, R_g = 1 Ω		40	60	
Fall Time	t _f			5	10	
Drain-Source Body Diode Characteris	tics					
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			40	А
Pulse Diode Forward Current ^a	I _{SM}				100	А
Body Diode Voltage	V _{SD}	I _S = 10 A		0.81	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			22	35	ns
Body Diode Reverse Recovery Charge	Q _{rr}	l _F = 20 A, dl/dt = 100 A/μs, T _J = 25 °C		14	25	nC
Reverse Recovery Fall Time				11		200
Reverse Recovery Rise Time	t _b			11		ns

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

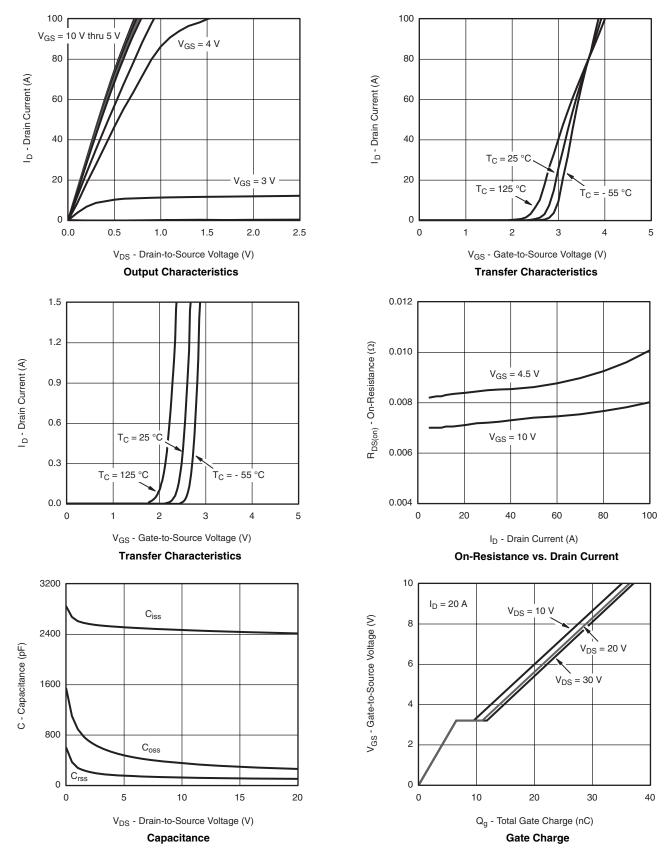
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



SUD50N04-8m8P

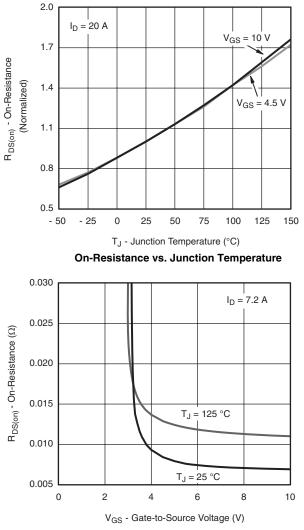
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Document Number: 68647 S10-0109-Rev. B, 18-Jan-10

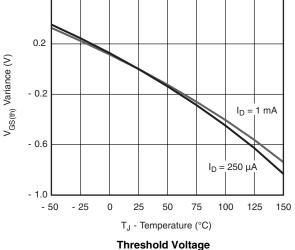
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

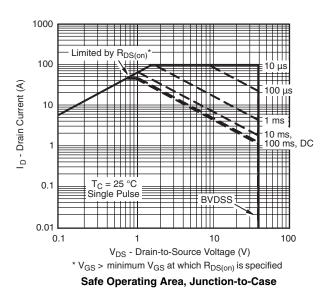


On-Resistance vs. Gate-to-Source Voltage



100 T_J = 25 °C 10 I_S - Source Current (A) T_J = 150 °C 1 0.1 . T_J = - 55 °C 0.01 0.001 0.2 0.4 1.0 0.0 0.6 0.8 1.2 V_{SD} - Source-to-Drain Voltage (V) Source-Drain Diode Forward Voltage 0.6



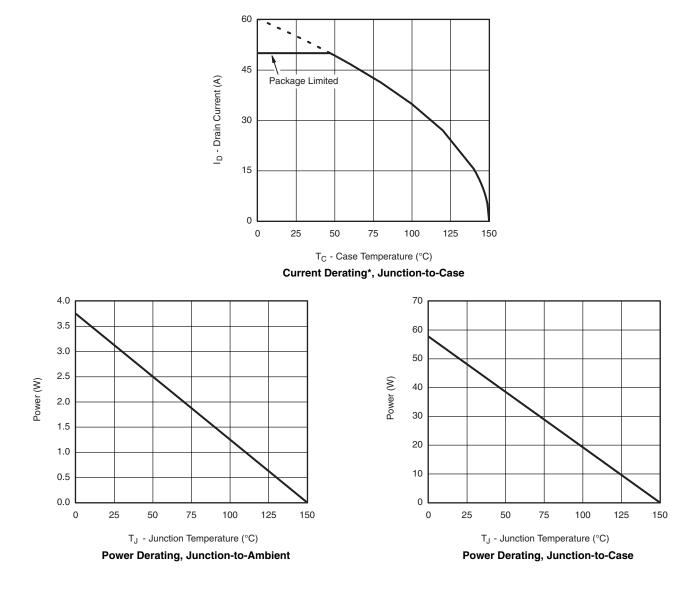


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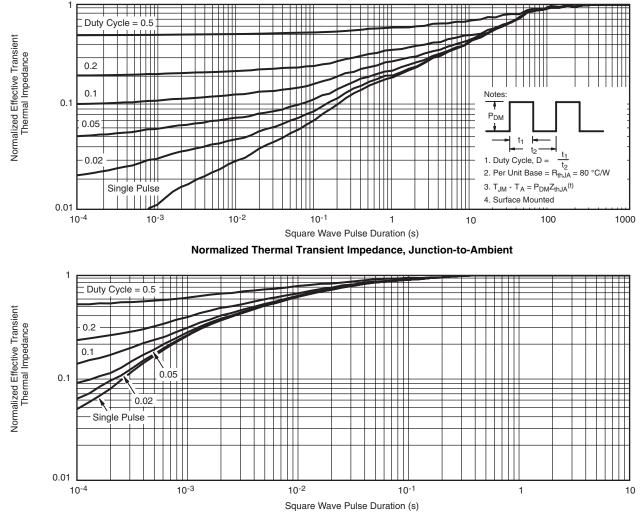
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

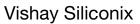


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



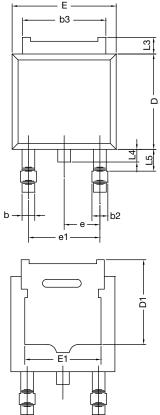
Normalized Thermal Transient Impedance, Junction-to-Case

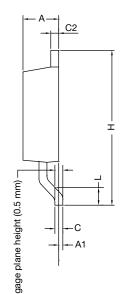
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TO-252AA Case Outline





	MILLIN	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	4.10	-	0.161	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28	3 BSC 0.090 BS		BSC	
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.01	1.52	0.040	0.060	
ECN: T16- DWG: 534	0236-Rev. P, ⁻ 7	16-May-16			

Notes

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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